SECTION C — CHEMISTRY; METALLURGY

- C23 COATING METALLIC MATERIAL; COATING MATERIAL WITH METALLIC MATERIAL; CHEMICAL SURFACE TREATMENT; DIFFUSION TREATMENT OF METALLIC MATERIAL; COATING BY VACUUM EVAPORATION, BY SPUTTERING, BY ION IMPLANTATION OR BY CHEMICAL VAPOUR DEPOSITION, IN GENERAL; INHIBITING CORROSION OF METALLIC MATERIAL OR INCRUSTATION IN GENERAL
- C23F NON-MECHANICAL REMOVAL OF METALLIC MATERIAL FROM SURFACES (working of metal by electro-erosion B23H; desurfacing by applying flames B23K 7/00; working metal by laser beam B23K 26/00); INHIBITING CORROSION OF METALLIC MATERIAL; INHIBITING INCRUSTATION IN GENERAL (treating metal surfaces or coating of metals by electrolysis or electrophoresis C25D, C25F); MULTI-STEP PROCESSES FOR SURFACE TREATMENT OF METALLIC MATERIAL INVOLVING AT LEAST ONE PROCESS PROVIDED FOR IN CLASS C23 AND AT LEAST ONE PROCESS COVERED BY SUBCLASS C21D OR C22F OR CLASS C25 [4]

Note(s)

- 1. This subclass <u>covers</u> inhibiting corrosion or incrustation in general, whether of or on metallic or non-metallic surfaces, subject to Note (2) below.
- This subclass does not cover:
 - protective layers or coating compositions or methods of applying them; these are classified in the appropriate places, e.g. B05, B44, C09D, C10M, C23C;
 - mechanical devices or constructional features of particular articles for inhibiting incrustation; these are classified in the appropriate places, e.g. in pipes or pipe fittings F16L 58/00;
 - articles characterised by being made of materials selected for their properties of resistance to corrosion or incrustation; these are classified in the appropriate places, e.g. turbine blades F01D 5/28.

Subclass index

| ETCHING, BRIGHTENING, COMPOSITIONS THEREFOR | 1/00, 3/00 |
|---|-------------|
| OTHER REMOVING OF METALLIC MATERIAL | 4/00 |
| INHIBITING CORROSION OR INCRUSTATION | 11/00-15/00 |
| MULTI-STEP SURFACE TREATMENTS | 17/00 |
| | |

| | TEP SURFACE TREATMENTS | |
|------|--|--|
| 1/00 | Etching metallic material by chemical means [1, 2, 2006.01] | 1/30 • • • • for etching other metallic material [4, 2006.01] |
| 1/02 | • Local etching [1, 2006.01] | 1/32 • • • Alkaline compositions (C23F 1/42 takes |
| 1/04 | Chemical milling [1, 2006.01] | precedence) [4, 2006.01] |
| 1/06 | • Sharpening files [1, 2006.01] | 1/34 • • • for etching copper or alloys |
| 1/08 | Apparatus, e.g. for photomechanical printing surfaces [1, 2006.01] | thereof [4, 2006.01] 1/36 • • • for etching aluminium or alloys |
| 1/10 | • Etching compositions (C23F 1/44 takes precedence) [4, 2006.01] | thereof [4, 2006.01] 1/38 • • • for etching refractory metals [4, 2006.01] |
| 1/12 | • • Gaseous compositions [4, 2006.01] | 1/40 • • • for etching other metallic |
| 1/14 | Aqueous compositions [4, 2006.01] | material [4, 2006.01] |
| 1/16 | • Acidic compositions (C23F 1/42 takes precedence) [4, 2006.01] | 1/42 • • containing a dispersed water-immiscible liquid [4, 2006.01] |
| 1/18 | • • • • for etching copper or alloys thereof [4, 2006.01] | Compositions for etching metallic material from a metallic material substrate of different |
| 1/20 | • • • for etching aluminium or alloys thereof [4, 2006.01] | composition [4, 2006.01] 1/46 • Regeneration of etching compositions [4, 2006.01] |
| 1/22 | • • • for etching magnesium or alloys thereof [4, 2006.01] | 3/00 Brightening metals by chemical means [1, 2, 2006.01] |
| 1/24 | • • • • for etching silicon or germanium [4, 2006.01] | 3/02 • Light metals [1, 2006.01]3/03 • with acidic solutions [4, 2006.01] |
| 1/26 | • • • • for etching refractory metals [4, 2006.01] | 3/04 • Heavy metals [1, 2006.01] |
| 1/28 | • • • for etching iron group metals [4, 2006.01] | 3/06 • • with acidic solutions [4, 2006.01] |
| | | |

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| 4/00 | Processes for removing metallic material from surfaces, not provided for in group C23F 1/00 or | 13/06 | Constructional parts, or assemblies of cathodic- protection apparatus [5, 2006.01] | |
|-----------------|---|---------|--|--|
| | C23F 3/00 [4, 2006.01] | 13/08 | • Electrodes specially adapted for inhibiting | |
| 4/02 | • by evaporation [4, 2006.01] | | corrosion by cathodic protection; Manufacture | |
| 4/04 | • by physical dissolution [4, 2006.01] | | thereof; Conducting electric current thereto [5, 2006.01] | |
| 11/00 | Inhibiting corrosion of metallic material by applying inhibitors to the surface in danger of corrosion or | 13/10 | • • • Electrodes characterised by the structure (C23F 13/16 takes precedence) [5, 2006.01] | |
| | adding them to the corrosive agent [1, 2006.01] | 13/12 | • • • • Electrodes characterised by the material | |
| 11/02 | in air or gases by adding vapour phase | | (C23F 13/16 takes precedence) [5, 2006.01] | |
| | inhibitors [1, 2006.01] | 13/14 | • • • • Material for sacrificial | |
| 11/04 | in markedly acid liquids [1, 2006.01] | | anodes [5, 2006.01] | |
| 11/06 | in markedly alkaline liquids [1, 2006.01] | 13/16 | • • • Electrodes characterised by the combination | |
| 11/08 | • in other liquids [1, 2006.01] | | of the structure and the material [5, 2006.01] | |
| 11/10 | • • using organic inhibitors [1, 2006.01] | 13/18 | • • • Means for supporting electrodes [5, 2006.01] | |
| | Note(s) | 13/20 | • • • • Conducting electric current to electrodes [5, 2006.01] | |
| | In groups C23F 11/12-C23F 11/173, the last place priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a compound | 13/22 | • • • • Monitoring arrangements therefor [5, 2006.01] | |
| | is classified in the last appropriate place. | 14/00 | Inhibiting incrustation in apparatus for heating | |
| 11/12 | • • • Oxygen-containing compounds [1, 2006.01] | | liquids for physical or chemical purposes (adding | |
| 11/14 | • • • Nitrogen-containing compounds [1, 2006.01] | | scale preventives or removers to water | |
| 11/16 | • • • Sulfur-containing compounds [1, 2006.01] | 1.4./00 | C02F 5/00) [1, 2, 2006.01] | |
| 11/167 | • • • Phosphorus-containing compounds [4, 2006.01] | 14/02 | • by chemical means [1, 2006.01] | |
| 11/173 11/18 | • • Macromolecular compounds [4, 2006.01]• using inorganic inhibitors [1, 2006.01] | 15/00 | Other methods of preventing corrosion or incrustation [1, 2006.01] | |
| 13/00 | Inhibiting corrosion of metals by anodic or cathodic protection [1, 2006.01] | 17/00 | Multi-step processes for surface treatment of metallic | |
| 13/02 | cathodic; Selection of conditions, parameters or procedures for cathodic protection, e.g. of electrical conditions [5, 2006.01] | | material involving at least one process provided for in class C23 and at least one process covered by subclass C21D or C22F or class C25 (coating for obtaining at least two superposed coatings either by | |
| 13/04 | Controlling or regulating desired parameters [5, 2006.01] | | methods not provided for in a single one of main groups C23C 2/00-C23C 26/00, or by combinations of methods provided for in subclasses C23C and C25D, C23C 28/00) [1, 4, 2006.01] | |